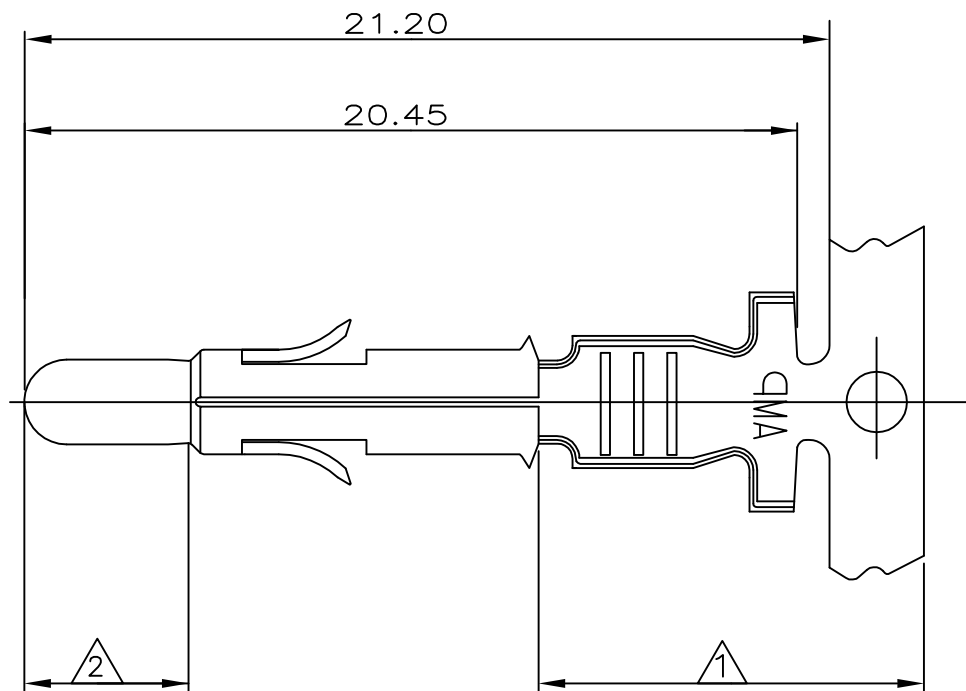
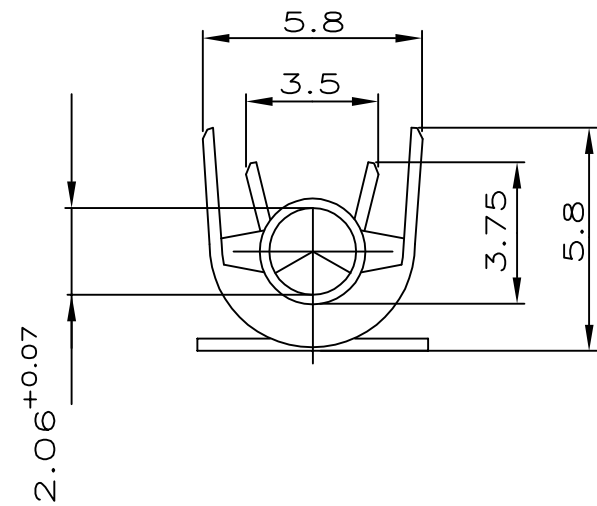
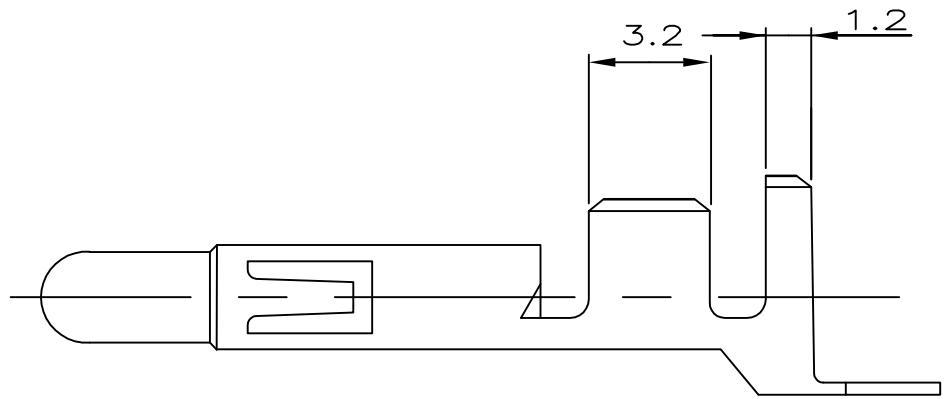


REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	G2	REVISED PER ECR-17-013854	22SEP2017	BDA	KR



- 1

2–6 μm Sn über Ni in der Crimpzone
- 2

0.8 μ m Gold über Nickel in der kontaktzone
- 3

Für isolations Ø3.3–5.1 mm geeignet

	926900-7	926868-7	CuZn30 F53	1	2
	926900-6	926868-6	CuSn4 F56	1	2
OBSOLETE	926900-5	926868-5	CuCrZr F50	vorverzinnt	—
OBSOLETE	926900-4	926868-4	CuCrZr F50	blank	—
	926900-3	926868-3	CuSn4 F56	vorverzinnt	—
	926900-1	926868-1	CuZn30 F53	vorverzinnt	—
	LOOSE PIECE	Bestell-Nr	werkstoff	Oberfläche	Farbe

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	21OCT2013	TE TE Connectivity	
		CHK	21OCT2013		
DIMENSIONS: mm		APVD	21OCT2013	NAME	
		PRODUCT SPEC	RAJENDRA PAI		
		APPLICATION SPEC	—	Universal M–N–L Stift DGB 1.5–2.5mm ² —	
		WEIGHT	—		
MATERIAL		FINISH	—	SIZE	RESTRICTED TO
			—	A200779C=926868	—
CUSTOMER DRAWING			SCALE	SHEET	REV
			1:1	1 of 1	G2